



Chip Beads

For power line

MPZ Series (For automobiles)

MPZ2012 Type

MPZ2012

2012[0805 inch]*

* Dimensions Code JIS[EIA]

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

REMINDERS

- The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- (1) Aerospace/Aviation equipment
- (2) Transportation equipment (electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

Chip Beads

For power line

Product compatible with RoHS directive

Halogen-free

Compatible with lead-free solders

AEC-Q200

Overview of MPZ2012 Type

FEATURES

- Noise reduction solution for power line.
- Compared to the MMZ Series, has low direct current resistance for compatibility with large currents, optimal for low power consumption.
- Various frequency characteristics with 5 materials of different features for countermeasures against everything from general signals to high-speed signals.
- Performs well even in signal lines where low direct current resistance is required.

APPLICATION

Various ECUs, powertrains, body controls, and car multimedia (telematics).

PART NUMBER CONSTRUCTION


MPZ	2012		S	121		A	T		D25
Series name	LxWxT Dimensions (mm)		Material name	Impedance (Ω) at 100MHz		Characteristic type	Packaging style		Internal code
	2012	2.0x1.25x0.85	S	121	120	A	T	Taping	D25

OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

Type	Temperature range		Package quantity (pieces/reel)	Individual weight (mg)
	Operating temperature (°C)	Storage temperature* (°C)		
MPZ2012	-55 to +125	-55 to +125	4,000	8

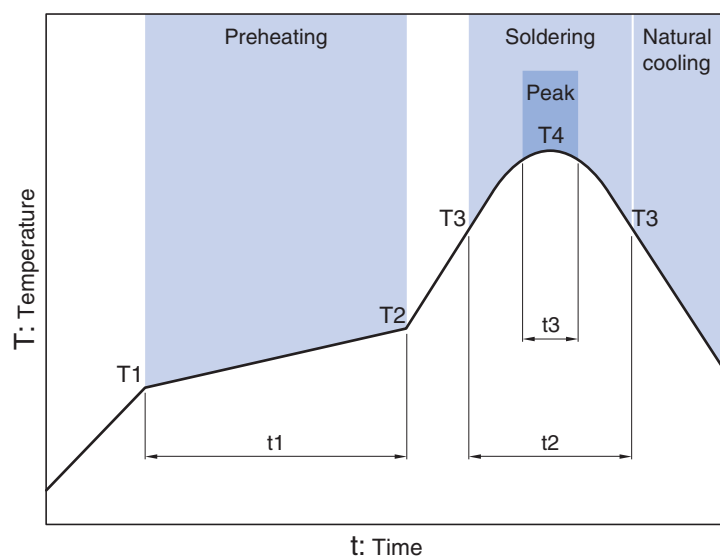
* The Storage temperature range is for after the circuit board is mounted.

- RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. <http://product.tdk.com/en/environment/rohs/>
- Halogen-free: Indicates that Cl content is less than 900ppm, Br content is less than 900ppm, and that the total Cl and Br content is less than 1500ppm.

 Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

MPZ2012 Type

RECOMMENDED REFLOW PROFILE



Preheating			Soldering		Peak	
Temp.	Time		Temp.	Time	Temp.	Time
T1	T2	t1	T3	t2	T4	t3
150°C	180°C	60 to 120s	230°C	30 to 60s	250 to 260°C	10s

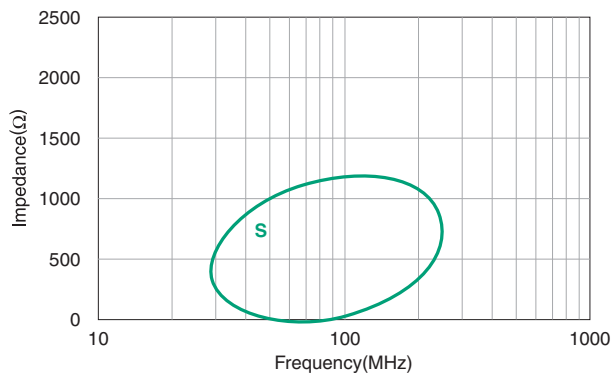
MPZ2012 Type

MATERIAL CHARACTERISTICS

S material: Standard type that features impedance characteristics similar to those of a typical ferrite core.

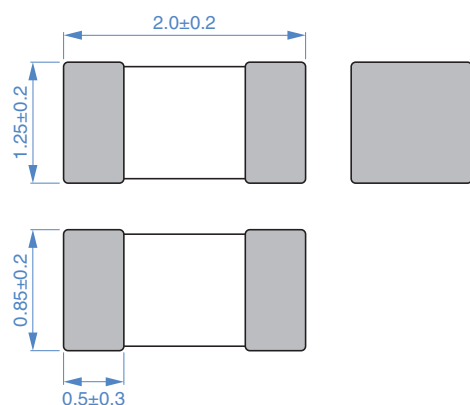
For signal line applications in which the blocking region is near 100MHz. Impedance values selected for effectiveness at 40 to 300MHz.

TYPICAL MATERIAL IMPEDANCE CHARACTERISTICS



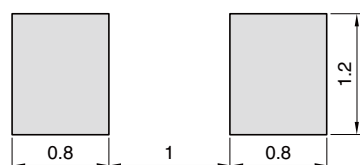
MPZ2012 Type

■ SHAPE & DIMENSIONS



Dimensions in mm

■ RECOMMENDED LAND PATTERN



Dimensions in mm

MPZ2012 Type

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

Impedance [100MHz] (Ω)		DC resistance (Ω)max.	Rated current* (A)max.	Part No.
Tolerance				
30	$\pm 10\Omega$	0.010	6	MPZ2012S300ATD25
100	$\pm 25\%$	0.020	4	MPZ2012S101ATD25
220	$\pm 25\%$	0.040	3	MPZ2012S221ATD25
330	$\pm 25\%$	0.050	2.5	MPZ2012S331ATD25
600	$\pm 25\%$	0.100	2	MPZ2012S601ATD25
1000	$\pm 25\%$	0.150	1.5	MPZ2012S102ATD25

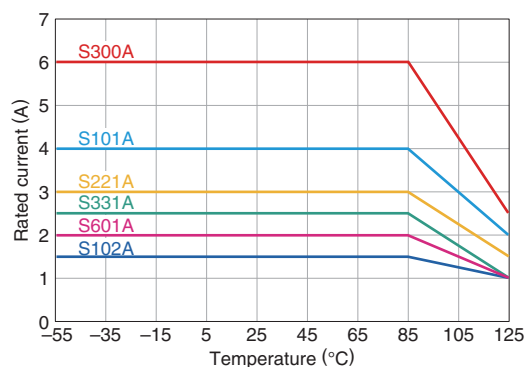
* Please refer to the graph of RATED CURRENT vs. TEMPERATURE CHARACTERISTICS (derating) about the rating current at 85°C or more in temperature of the product.

Measurement equipment

Measurement item	Product No.	Manufacturer
Impedance	E4991A+16192A	Agilent Technologies
DC resistance	Type-7556	Yokogawa

* Equivalent measurement equipment may be used.

Rated current vs. temperature characteristics (derating)

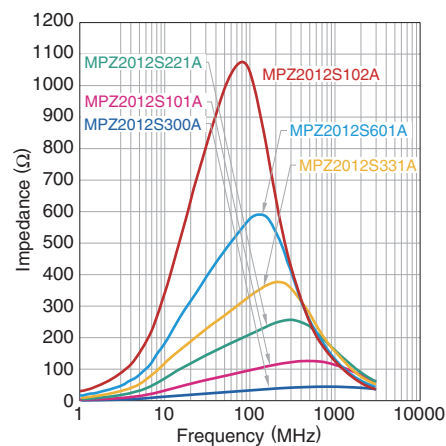


MPZ2012 Type

ELECTRICAL CHARACTERISTICS

Z VS. FREQUENCY CHARACTERISTICS (BY SERIES)

MPZ2012S SERIES

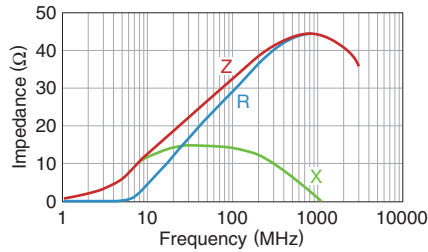


MPZ2012 Type

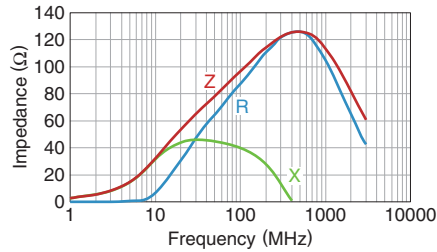
ELECTRICAL CHARACTERISTICS

Z, X, R VS. FREQUENCY CHARACTERISTICS

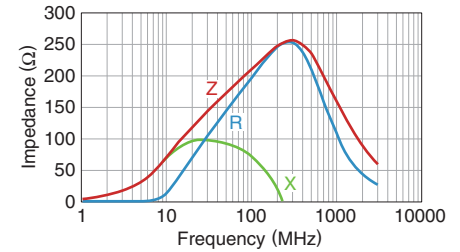
MPZ2012S300ATD25



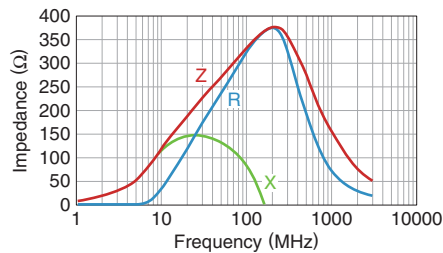
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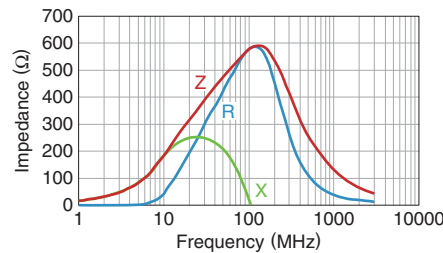
MPZ2012S221ATD25



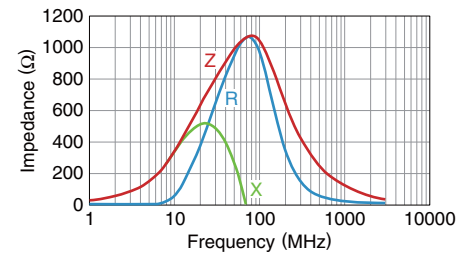
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MPZ2012S601ATD25



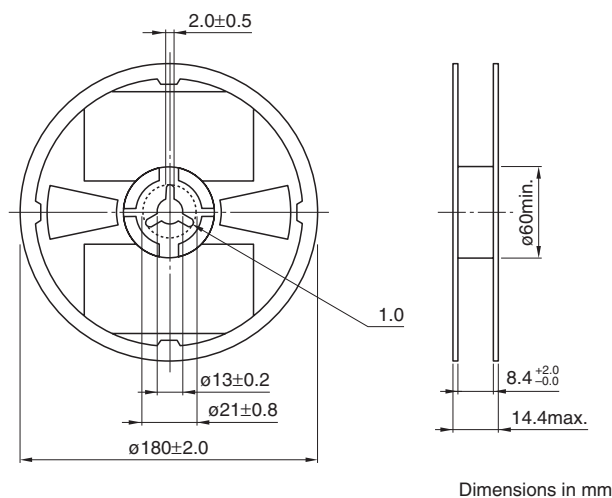
MPZ2012S102ATD25



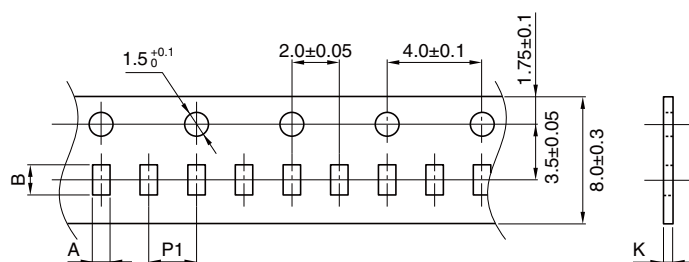
MPZ2012 Type

PACKAGING STYLE

REEL DIMENSIONS



TAPE DIMENSIONS



Type	A	B	P1	K
MPZ2012	1.5 ± 0.2	2.3 ± 0.2	4.0 ± 0.1	1.1max.

